



PNP Silicon Low-Power Transistor Qualified per MIL-PRF-19500/485

Qualified Levels: JAN, JANTX, JANTXV and JANS

DESCRIPTION

This family of 2N5415 and 2N5416 epitaxial planar transistors are military qualified up to a JANS level for high-reliability applications. These devices are also available in TO-39 and low profile U4 and UA packaging.

Important: For the latest information, visit our website http://www.microsemi.com.

FEATURES

- JEDEC registered 2N5415 through 2N5416 series
- JAN, JANTXV, and JANS qualifications are available per MIL-PRF-19500/485.
 (See part nomenclature for all available options.)
- RoHS compliant

APPLICATIONS / BENEFITS

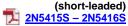
- General purpose transistors for low power applications requiring high frequency switching.
- Low package profile
- Military and other high-reliability applications



TO-5 Package

Also available in:

TO-205AD (TO-39) package



U4 package (surface mount)

1 2N5415U4 – 2N5416U4

UA package (surface mount) **1** <u>2N5415UA – 2N5416UA</u>

MAXIMUM RATINGS @ T_A = +25 °C unless otherwise noted

| Parameters / Test Conditions | Symbol | 2N5415 | 2N5416 | Unit |
|---|------------------|------------|--------|------|
| Collector-Emitter Voltage | V _{CEO} | 200 | 300 | V |
| Collector-Base Voltage | V _{CBO} | 200 | 350 | V |
| Emitter-Base Voltage | V _{EBO} | 6.0 | 6.0 | V |
| Collector Current | Ic | 1.0 1.0 | | Α |
| Operating & Storage Junction Temperature Range | T_J, T_{stg} | -65 to | °C | |
| Thermal Resistance Junction-to-Ambient | R _{ÐJA} | 234 | | °C/W |
| Thermal Resistance Junction-to-Case | R _{eJC} | 17.5 | | °C/W |
| Total Power Dissipation @ $T_A = +25 ^{\circ}\text{C}^{\ (1)}$ @ $T_C = +25 ^{\circ}\text{C}^{\ (2)}$ | P _T | 0.75 10 | | W |

Notes: 1. Derate linearly 4.29 mW/°C for T_A > +25 °C

2. Derate linearly 57.2 mW/°C for $T_C > +25$ °C

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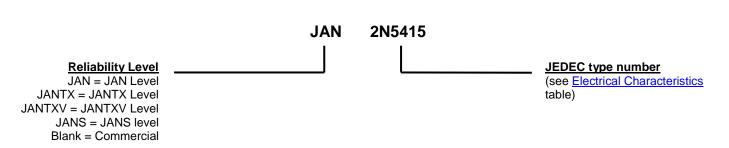
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MECHANICAL and PACKAGING

- CASE: Hermetically sealed, kovar base, nickel cap
- TERMINALS: Leads are gold plated kovar (Solder dip (Sn63/Pb37) is available upon special request. NOTE: Solder dipping will eliminate RoHS compliance.)
- · MARKING: Part number, date code, manufacturer's ID
- POLARITY: NPN
- WEIGHT: Approximately 1.14 grams
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE



| SYMBOLS & DEFINITIONS | | | | |
|-----------------------|--|--|--|--|
| Symbol | Definition | | | |
| C_obo | Common-base open-circuit output capacitance | | | |
| I _{CEO} | Collector cutoff current, base open | | | |
| I _{CEX} | Collector cutoff current, circuit between base and emitter | | | |
| I _{EBO} | Emitter cutoff current, collector open | | | |
| h_{FE} | Common-emitter static forward current transfer ratio | | | |
| V_{CEO} | Collector-emitter voltage, base open | | | |
| V_{CBO} | Collector-emitter voltage, emitter open | | | |
| V_{EBO} | Emitter-base voltage, collector open | | | |



ELECTRICAL CHARACTERISTICS @ T_A = +25 °C, unless otherwise noted

OFF CHARACTERISTICS

| Parameters / Test Conditions | | Symbol | Min. | Max. | Unit |
|--|--------|-------------------|------|------|-------|
| Collector-Emitter Breakdown Voltage | | | | | |
| $I_C = 50 \text{ mA}, I_B = 5 \text{ mA},$ | 2N5415 | $V_{(BR)CEO}$ | 200 | | V |
| L = 25 mH; $f = 30 - 60 Hz$ | 2N5416 | | 300 | | |
| Emitter-Base Cutoff Current | | l | | 20 | μA |
| $V_{EB} = 6.0 \text{ V}$ | | I _{EBO} | | 20 | μΛ |
| Collector-Emitter Cutoff Current | | | | | |
| $V_{CE} = 200 \text{ V}, V_{BE} = 1.5 \text{ V}$ | 2N5415 | I_{CEX} | | 50 | μΑ |
| $V_{CE} = 300 \text{ V}, V_{BE} = 1.5 \text{ V}$ | 2N5416 | | | | |
| Collector-Emitter Cutoff Current | | | | | |
| V _{CE} = 150 V | 2N5415 | I _{CEO1} | | 50 | μΑ |
| $V_{CE} = 250 \text{ V}$ | 2N5416 | | | | |
| Collector-Emitter Cutoff Current | | | | | |
| $V_{CE} = 200 \text{ V}$ | 2N5415 | I _{CEO2} | | 1 | mΑ |
| $V_{CE} = 300 \text{ V}$ | 2N5416 | | | | |
| Collector-Base Cutoff Current | | | | | |
| $V_{CB} = 175 \text{ V}$ | 2N5415 | I _{CBO1} | | 50 | μΑ |
| $V_{CB} = 280 \text{ V}$ | 2N5416 | | | | |
| $V_{CB} = 200 \text{ V}$ | 2N5415 | I _{CBO2} | | 500 | μА |
| $V_{CB} = 350 \text{ V}$ | 2N5416 | LCRO5 | | 300 | μΛ |
| $V_{CB} = 175 \text{ V}, T_A = +150 {}^{\circ}\text{C}$ | 2N5415 | Longo | | 1 | mΑ |
| $V_{CB} = 280 \text{ V}, T_A = +150 {}^{\circ}\text{C}$ | 2N5416 | I _{CBO3} | | ı | 111/- |

ON CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
|---|----------------------|----------------|------|------|
| Forward-Current Transfer Ratio $I_C = 50$ mA, $V_{CE} = 10$ V $I_C = 1$ mA, $V_{CE} = 10$ V $I_C = 50$ mA, $V_{CE} = 10$ V, $T_A = +150$ °C | h _{FE} | 30 15 15 | 120 | |
| Collector-Emitter Saturation Voltage I _C = 50 mA, I _B = 5 mA | V _{CE(sat)} | | 2.0 | ٧ |
| Base-Emitter Voltage Non-Saturation $I_C = 50$ mA, $V_{CE} = 10$ V | V_{BE} | | 1.5 | V |

DYNAMIC CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
|---|------------------|------|------|------|
| Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V}, f = 5 \text{ MHz}$ | h _{fe} | 3 | 15 | |
| Small-signal short Circuit Forward-Current Transfer Ratio $I_C = 5 \text{ mA}, V_{CE} = 10 \text{ V}, f \le 1 \text{ kHz}$ | h _{fe} | 25 | | |
| Output Capacitance $V_{CB} = 10 \text{ V}, I_E = 0, 100 \text{ kHz} \le f \le 1 \text{ MHz}$ | C _{obo} | | 15 | pF |



ELECTRICAL CHARACTERISTICS @ T_A = +25 °C unless otherwise noted. (continued)

SWITCHING CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
|---|------------------|------|------|------|
| Turn-On Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = 5 \text{ mA}$ | t _{on} | | 1 | μs |
| Turn-Off Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = I_{B2} = 5 \text{ mA}$ | t _{off} | | 10 | μs |

SAFE OPERATING AREA (See SOA graph below and MIL-STD-750, method 3053)

DC Tests

 $T_C = +25 \, ^{\circ}\text{C}, \, t_P = 0.4 \, \text{s}, \, 1 \, \text{Cycle}$

Test 1

 $V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ A}$

Test 2

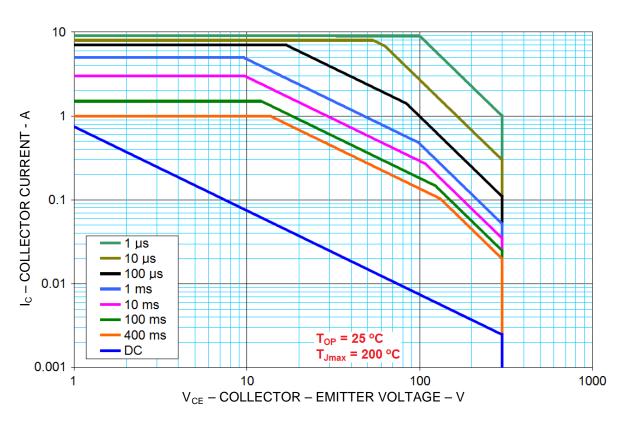
 V_{CE} = 100 V, I_{C} = 100 mA

Test 3

 $V_{CE} = 200 \text{ V}, I_{C} = 24 \text{ mA } (2N5415 \text{ only})$

Test 4

 $V_{CE} = 300 \text{ V}, I_{C} = 10 \text{ mA} (2N5416 \text{ only})$



Maximum Safe Operating Area (T_J = 200 °C)



GRAPHS

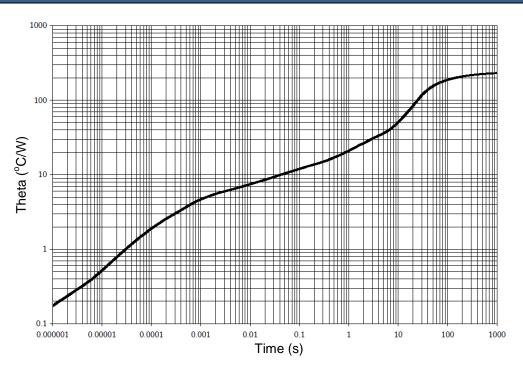


FIGURE 1
Thermal impedance graph (R_{OJA})

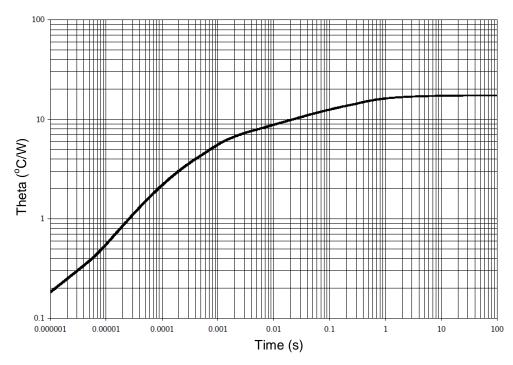
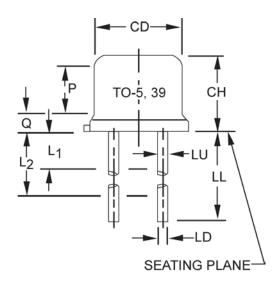


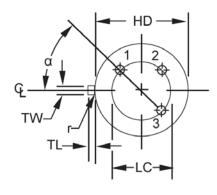
FIGURE 2
Thermal impedance graph (R_{OJA})

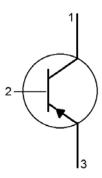


PACKAGE DIMENSIONS



| | Dimensions | | | | |
|--------|------------|------------------------|--------|------|--------|
| Symbol | In | ch | Millim | Note | |
| | Min | Max | Min | Max | |
| CD | 0.305 | 0.335 | 7.75 | 8.51 | |
| CH | 0.240 | 0.260 | 6.10 | 6.60 | |
| HD | 0.335 | 0.370 | 8.51 | 9.40 | |
| LC | 0.20 | 00 TP | 5.08 | TP | 6 |
| LD | 0.016 | 0.021 | 0.41 | 0.53 | 7 |
| LL | 93 | See notes 7, 12 and 13 | | | |
| LU | 0.016 | 0.019 | 0.41 | 0.48 | 7, 13 |
| L1 | - | 0.050 | - | 1.27 | 13 |
| L2 | 0.250 | - | 6.35 | - | 13 |
| Р | 0.100 | - | 2.54 | - | 5 |
| Q | - | 0.050 | - | 1.27 | 4 |
| TL | 0.029 | 0.045 | 0.74 | 1.14 | 3 |
| TW | 0.028 | 0.034 | 0.71 | 0.86 | 10, 11 |
| r | - | 0.010 | - | 0.25 | 11 |
| α | 45 | ° TP | 45° TP | | 6 |





NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for information only.
- 3. Symbol TL is measured from HD maximum.
- 4. Details of outline in this zone are optional.
- 5. Symbol CD shall not vary more than 0.010 (0.25 mm) in zone P. This zone is controlled for automatic handling.
- 6. Leads at gauge plane 0.054 inch (1.37 mm) +0.001 inch (0.03 mm) -0.000 inch (0.00 mm) below seating plane shall be within 0.007 inch (0.18 mm) radius of true position (TP) relative to tab. Device may be measured by direct methods or by gauge.
- 7. Symbol LD applies between L1 and L2. Dimension LD applies between L2 and LL minimum. Lead diameter shall not exceed 0.042 inch (1.07 mm) within L1 and beyond LL minimum.
- 8. Lead designation, shall be as follows: 1 emitter, 2 base, 3 collector.
- 9. Lead number three is electrically connected to case.
- 10. Beyond r maximum, TW shall be held for a minimum length of 0.011 inch (0.28 mm).
- 11. Symbol r applied to both inside corners of tab.
- 12. For transistor types 2N5415 and 2N5416, dimension LL shall be 1.5 inches (38.1 mm) minimum and 1.75 inch (44.4 mm) maximum.
- 13. All three leads.
- 14. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.